ALPHA & OMEGA SEMICONDUCTOR

AOT42S60L/AOB42S60L

600V 37A αMOS^{TM} Power Transistor

General Description

The AOT42S60L & AOB42S60L have been fabricated using the advanced αMOS^{TM} high voltage process that is designed to deliver high levels of performance and robustness in switching applications.
By providing low $R_{DS(on)}$, Q_g and E_{OSS} along with guaranteed avalanche capability these devices can be adopted quickly into new and existing offline power supply designs.

Product Summary

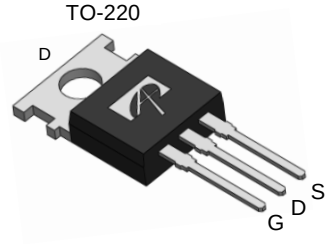
V_{DS} @ $T_{j,max}$	700V
I_{DM}	166A
$R_{DS(ON),max}$	0.109Ω
$Q_{g,typ}$	40nC
E_{oss} @ 400V	9.2µJ

100% UIS Tested
100% R_g Tested

Green Product

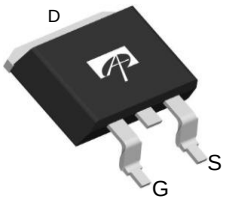
Top View

TO-220

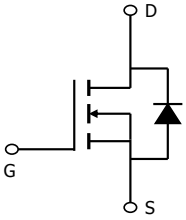


AOT42S60L

TO-263
D2PAK



AOB42S60L



Orderable Part Number	Package Type	Form	Minimum Order Quantity
AOT42S60L	TO-220 Green	Tube	1000
AOB42S60L	TO-263 Green	Tape & Reel	800

Absolute Maximum Ratings T_A=25°C unless otherwise noted

Parameter		Symbol	AOT42S60L/AOB42S60L	Units
Drain-Source Voltage		V_{DS}	600	V
Gate-Source Voltage		V_{GS}	±30	V
Continuous Drain Current	T_C=25°C	I_D	37	A
	T_C=100°C		23	
Pulsed Drain Current [C]		I_{DM}	166	
Avalanche Current [C]		I_{AR}	11	A
Repetitive avalanche energy [C]		E_{AR}	234	mJ
Single pulsed avalanche energy [G]		E_{AS}	1345	mJ
Power Dissipation [B]	T_C=25°C	P_D	417	W
	Derate above 25°C		3.3	W/ °C
MOSFET dv/dt ruggedness		dv/dt	100	V/ns
Peak diode recovery dv/dt [H]			20	
Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 150	°C
Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds [J]		T_L	300	°C

Thermal Characteristics

Parameter	Symbol	AOT42S60L/AOB42S60L	Units
Maximum Junction-to-Ambient [A,D]	$R_{\theta JA}$	65	°C/W
Maximum Case-to-sink [A]	$R_{\theta CS}$	0.5	°C/W
Maximum Junction-to-Case	$R_{\theta JC}$	0.3	°C/W

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	I_D=250µA, V_{GS}=0V, T_J=25°C	600	-	-	V
		I_D=250µA, V_{GS}=0V, T_J=150°C	650	700	-	
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}=600V, V_{GS}=0V	-	-	1	µA
		V_{DS}=480V, T_J=150°C	-	10	-	
I_{GSS}	Gate-Body leakage current	V_{DS}=0V, V_{GS}=±30V	-	-	±100	nA
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=5V,I_D=250µA	2.5	3.2	3.8	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	V_{GS}=10V, I_D=21A, T_J=25°C	-	0.095	0.109	Ω
		V_{GS}=10V, I_D=21A, T_J=150°C	-	0.27	0.31	Ω
V_{SD}	Diode Forward Voltage	I_S=21A,V_{GS}=0V, T_J=25°C	-	0.84	-	V
I_S	Maximum Body-Diode Continuous Current		-	-	37	A
I_{SM}	Maximum Body-Diode Pulsed Current		-	-	166	A
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	V_{GS}=0V, V_{DS}=100V, f=1MHz	-	2154	-	pF
C_{oss}	Output Capacitance		-	135	-	pF
$C_{o(er)}$	Effective output capacitance, energy related [H]	V_{GS}=0V, V_{DS}=0 to 480V, f=1MHz	-	103	-	pF
$C_{o(tr)}$	Effective output capacitance, time related [I]		-	344	-	pF
C_{rss}	Reverse Transfer Capacitance	V_{GS}=0V, V_{DS}=100V, f=1MHz	-	2.7	-	pF
R_g	Gate resistance	V_{GS}=0V, V_{DS}=0V, f=1MHz	-	1.7	-	Ω
SWITCHING PARAMETERS						
Q_g	Total Gate Charge	V_{GS}=10V, V_{DS}=480V, I_D=21A	-	40	-	nC
Q_{gs}	Gate Source Charge		-	11.7	-	nC
Q_{gd}	Gate Drain Charge		-	11.9	-	nC
$t_{D(on)}$	Turn-On DelayTime	V_{GS}=10V, V_{DS}=400V, I_D=21A, R_G=25Ω	-	38.5	-	ns
t_r	Turn-On Rise Time		-	53	-	ns
$t_{D(off)}$	Turn-Off DelayTime		-	136	-	ns
t_f	Turn-Off Fall Time		-	46	-	ns
t_{rr}	Body Diode Reverse Recovery Time	I_F=21A,dI/dt=100A/µs,V_{DS}=400V	-	473	-	ns
I_{rm}	Peak Reverse Recovery Current	I_F=21A,dI/dt=100A/µs,V_{DS}=400V	-	38.5	-	A
Q_{rr}	Body Diode Reverse Recovery Charge	I_F=21A,dI/dt=100A/µs,V_{DS}=400V	-	10.5	-	µC

A. The value of $R_{\theta JA}$ is measured with the device in a still air environment with T_A =25° C.
B. The power dissipation P_D is based on $T_{J(MAX)}$=150° C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.
C. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}$=150° C, Ratings are based on low frequency and duty cycles to keep initial T_J =25° C.
D. The $R_{\theta JA}$ is the sum of the thermal impedance from junction to case $R_{\theta JC}$ and case to ambient.
E. The static characteristics in Figures 1 to 6 are obtained using <300 µs pulses, duty cycle 0.5% max.
F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of $T_{J(MAX)}$=150° C. The SOA curve provides a single pulse rating.
G. L=60mH, I_{AS}=6.7A, V_{DD}=150V, Starting T_J=25° C
H. $C_{o(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 80% $V_{(BR)DSS}$.
I. $C_{o(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% $V_{(BR)DSS}$.
J. Wavesoldering only allowed at leads.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

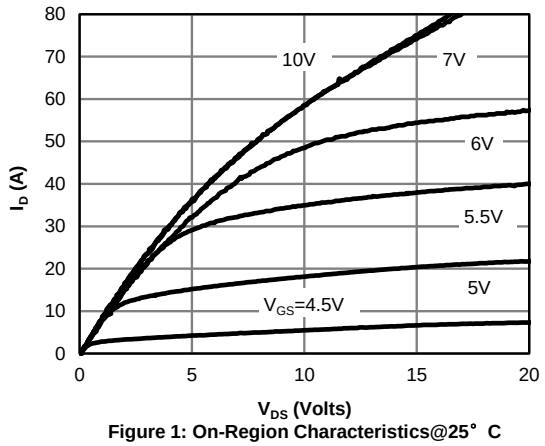


Figure 1: On-Region Characteristics@25° C

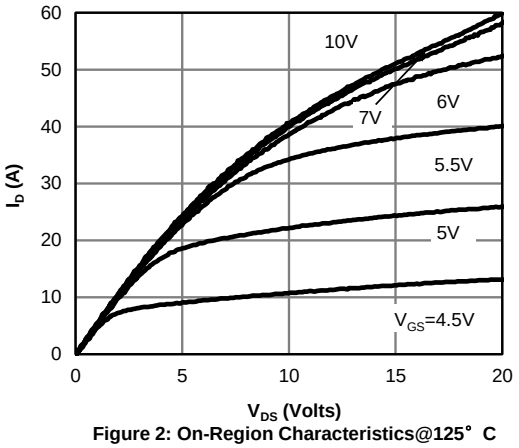


Figure 2: On-Region Characteristics@125° C

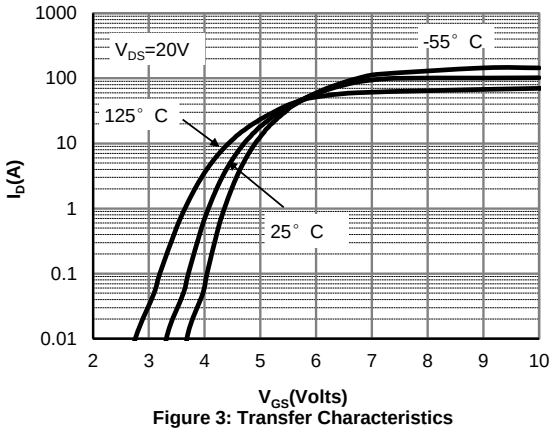


Figure 3: Transfer Characteristics

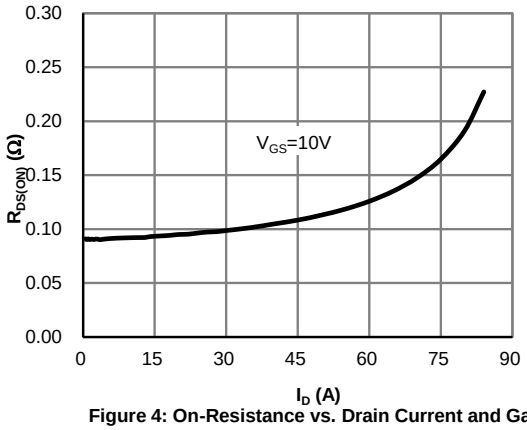


Figure 4: On-Resistance vs. Drain Current and Gate Voltage

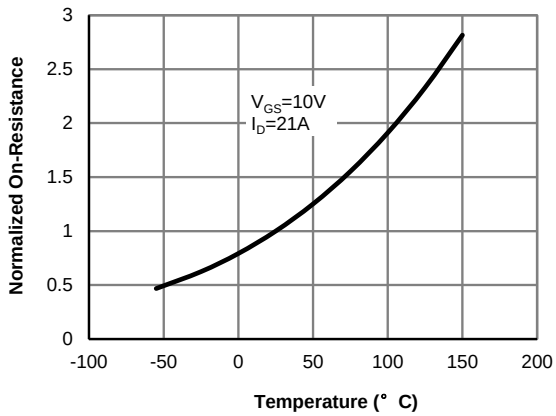


Figure 5: On-Resistance vs. Junction Temperature

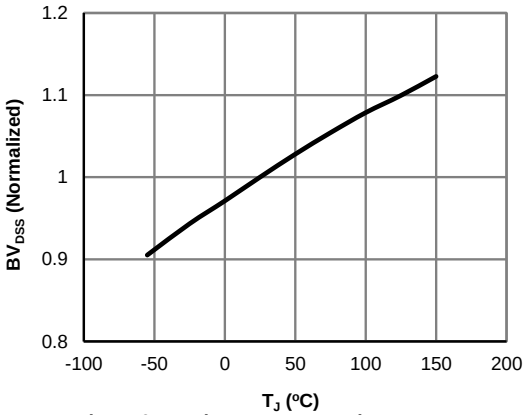


Figure 6: Break Down vs. Junction Temperature

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

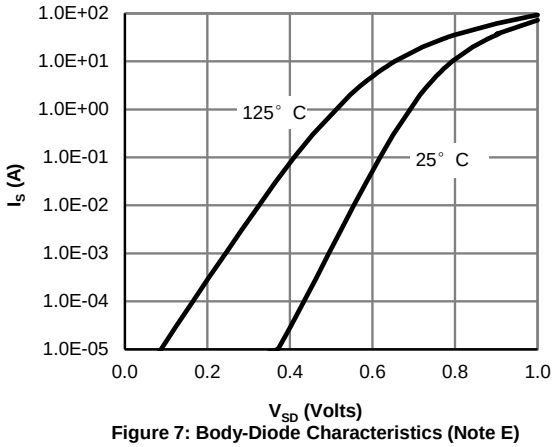


Figure 7: Body-Diode Characteristics (Note E)

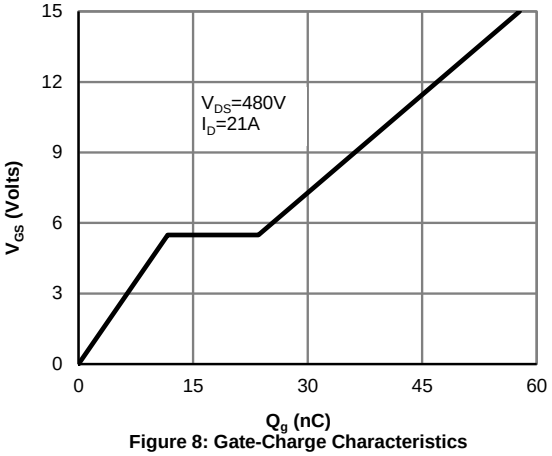


Figure 8: Gate-Charge Characteristics

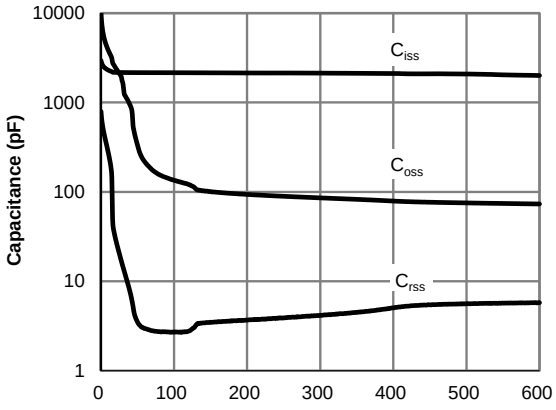


Figure 9: Capacitance Characteristics

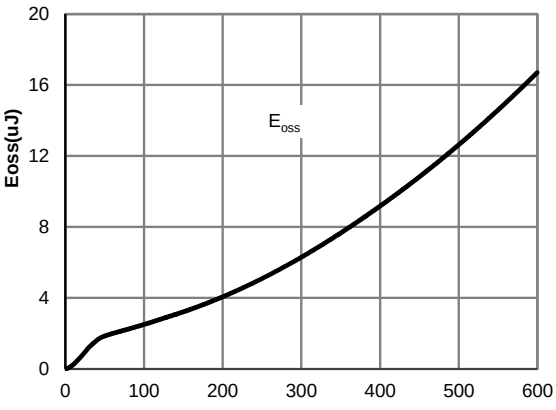


Figure 10: Coss stored Energy

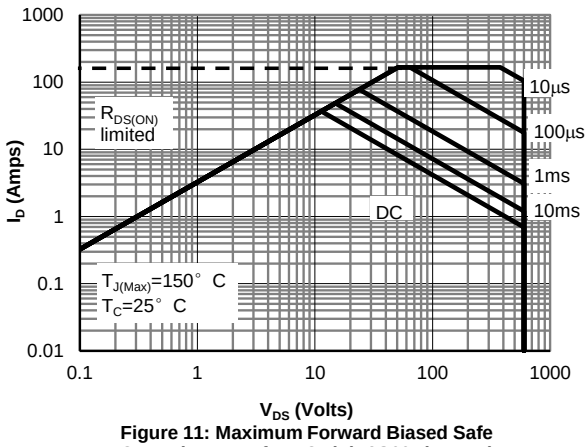


Figure 11: Maximum Forward Biased Safe Operating Area for AOT(B)42S60L(Note F)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

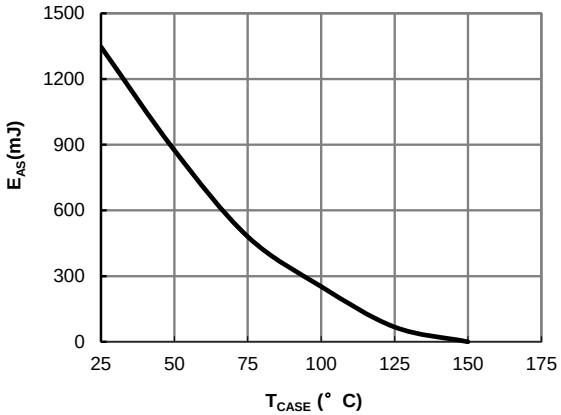


Figure 12: Avalanche energy

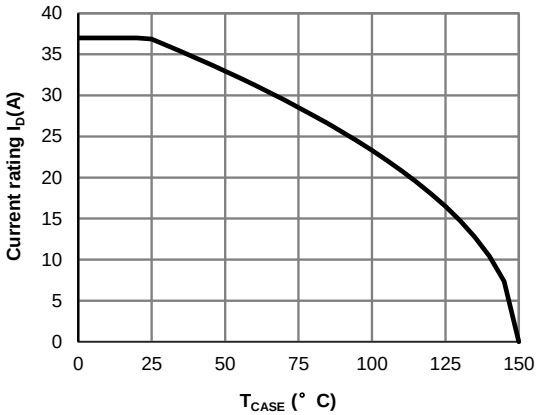


Figure 13: Current De-rating (Note B)

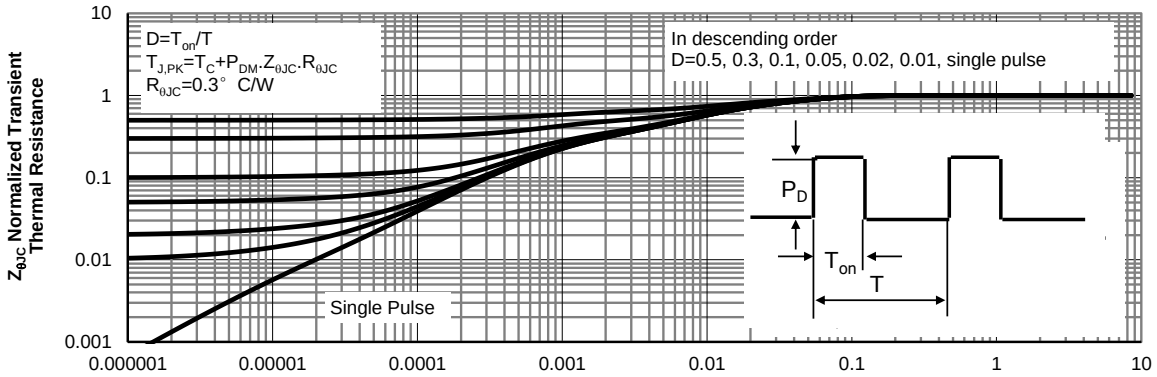
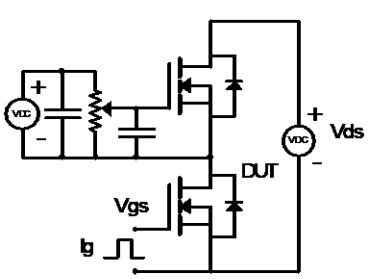
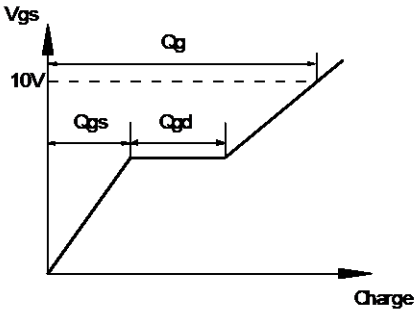


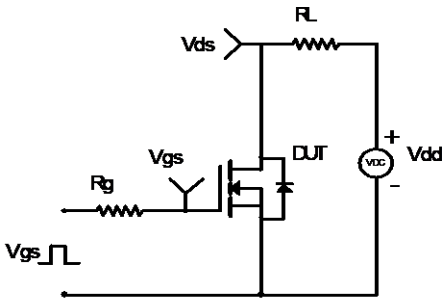
Figure 14: Normalized Maximum Transient Thermal Impedance for AOT(B)42S60L(Note F)

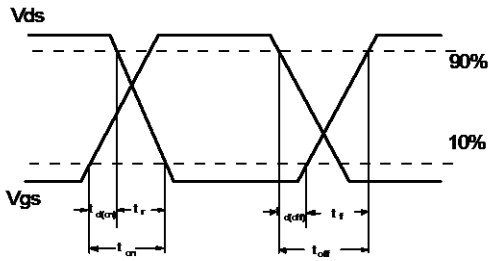
Gate Charge Test Circuit & Waveform



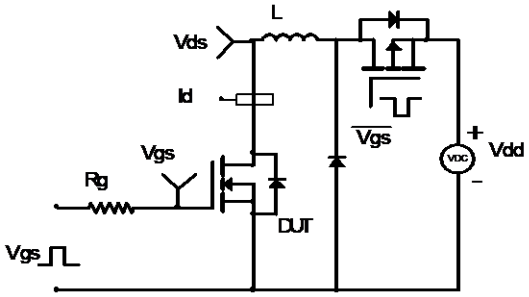


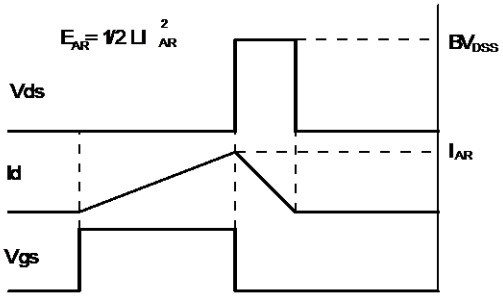
Resistive Switching Test Circuit & Waveforms



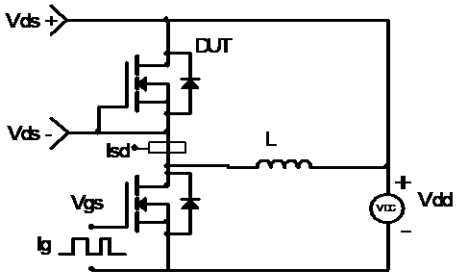


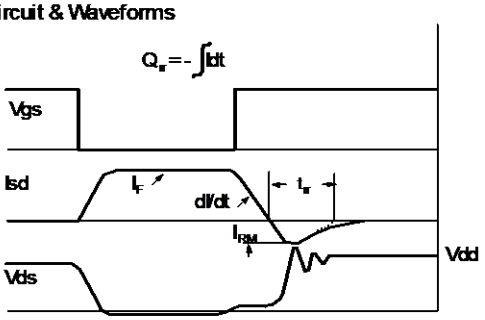
Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





Diode Recovery Test Circuit & Waveforms





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